

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

1. (Currently Amended) An apparatus for output impedance matching for a multi-band signal processor comprising:

a multi-band diplexer adapted for receiving input signals having a defined frequency band and generating at least first and second output signals, wherein the first output signals are of a frequency band that is higher than a frequency band of the second output signals; and

at least one switch through which the first output signals from the multi-band diplexer pass, the switch having [""]on[""] and [""]off[""] states, the switch being in an [""]on[""] state when the input signals are of a first frequency band, for suppressing undesired harmonics, and the switch being in an [""]off[""] state when the input signals are of a second frequency band.

2. (Original) An apparatus according to claim 1, further comprising at least one impedance matching section connected with the multi-band diplexer through which at least one of the first output signals and the second output signals are passed.

3. (Original) An apparatus according to claim 1, further comprising a first impedance matching section connected with the multi-band diplexer through which the second output signals pass.
4. (Original) An apparatus according to claim 3, further comprising a second impedance matching section connected with the switch through which the first output signals pass.
5. (Original) An apparatus according to claim 1, wherein the multi-band signal processor comprises an active device for transmitting the input signals that are received by the multi-band diplexer, the apparatus further comprising an impedance matching section connected between the active device and the multi-band diplexer through which the input signals pass.
6. (Original) An apparatus according to claim 1, wherein the multi-band signal processor comprises an active device transmitting the input signals that are received by the multi-band diplexer, and a load receiving the first and second output signals generated by the multi-band diplexer , the apparatus further comprising:
 - an impedance matching section connected between the active device and the multi-band diplexer through which the input signals pass;
 - a first impedance matching section connected between the multi-band diplexer and the load through which the second output signals pass; and

a second impedance matching section connected between the switch and the load through which the first output signals pass.

7. (Original) An apparatus according to claim 1, wherein the switch comprises a PIN-diode.
8. (Original) An apparatus according to claim 1, wherein the input signals comprise the second frequency band being of a higher frequency band than the first frequency band.
9. (Original) An apparatus according to claim 1, wherein the multi-band signal processor comprises an active device transmitting the input signals that are received by the multi-band diplexer, the active device being selected from the group consisting of a power amplifier and an attenuator.
10. (Currently Amended) A method for output matching in a multi-band signal processor comprising:
 - receiving input signals having a defined frequency band and generating at least first and second output signals to a load, with the first output signals being of a frequency band that is higher than a frequency band of the second output signals; and
 - regulating the first output signals according to the defined frequency band of the input signals, with undesired harmonics being suppressed from the first output signals when the input signals are of a first frequency band;

wherein the first output signals are regulated by at least one switch having on and off states, the method further comprising operating the switch in an on state when the input signals are of the first frequency band, for suppressing undesired harmonics, and operating the switch in an off state when the input signals are of a second frequency band.

11. (Canceled).

12. (Original) A method according to claim 10, further comprising matching impedances of the first and second output signals separately.

13. (Original) A method according to claim 12, wherein the receiving and generating step comprises a multi-band diplexer, and the step of matching impedances further comprises:

providing a first impedance matching section between the multi-band diplexer and the load through which the second output signals pass; and

providing a second impedance matching section between the multi-band diplexer and the load through which the first output signals pass.

14. (Original) A method according to claim 10, wherein the multi-band signal processor comprises an active device transmitting the input signals, and wherein the receiving and generating step comprises a multi-band diplexer, the method further

comprising providing an impedance matching section between the active device and the multi-band diplexer through which the input signals pass.

15. (Currently Amended) An amplifier output impedance matching configuration comprising:

a multi-band diplexer receiving input signals having a defined frequency band from a power amplifier and generating at least first and second output signals to a load, wherein the first output signals are of a frequency band that is higher than a frequency band of the second output signals;

at least one switch connected between the multi-band diplexer and the load for receiving the first output signals from the multi-band diplexer, the switch having [""]on[""] and [""]off[""] states, the switch being in an [""]on[""] state when the input signals are of a first frequency band, for suppressing undesired harmonics, and the switch being in an [""]off[""] state when the input signals are of a second frequency band; and

one or more impedance matching sections connected between at least one of:

the multi-band diplexer and the load through which at least one of the first outputs signals and the second output signals are passed; and

the power amplifier and the multi-band diplexer through which the input signals pass.

16. (Original) An amplifier output impedance matching configuration according to claim 15 further comprising a first impedance matching section connected between the

multi-band diplexer and the load through which the second output signals pass and a second impedance matching section connected between the switch and the load through which the first output signals pass.

17. (Original) An amplifier output impedance matching configuration according to claim 15, further comprising:

an impedance matching section connected between the power amplifier and the multi-band diplexer through which the input signals pass;

a first impedance matching section connected between the multi-band diplexer and the load through which the second output signals pass; and a second impedance matching section connected between the switch and the load through which the first output signals pass.

18. (Original) An amplifier output impedance matching configuration according to claim 15, wherein the switch comprises a PIN-diode.

19. (Original) An amplifier output impedance matching configuration according to claim 15, wherein the input signals comprise the second frequency band being of a higher frequency band than the first frequency band.

20. (New) A method for output matching in a multi-band signal processor comprising:

receiving input signals having a defined frequency band and generating at least first and second output signals to a load, with the first output signals being of a frequency band that is higher than a frequency band of the second output signals; and

regulating the first output signals according to the defined frequency band of the input signals, with undesired harmonics being suppressed from the first output signals when the input signals are of a first frequency band;

matching impedances of the first and second output signals separately;

wherein the receiving and generating step comprises a multi-band diplexer, and the step of matching impedances further comprises:

providing a first impedance matching section between the multi-band diplexer and the load through which the second output signals pass; and

providing a second impedance matching section between the multi-band diplexer and the load through which the first output signals pass.